

Standard Power MOSFETs

RFH30N12, RFH30N15

File Number 1633

Power MOS Field-Effect Transistors

N-Channel Enhancement-Mode Power Field-Effect Transistors

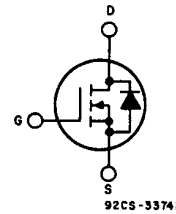
30 A, 120 V - 150 V

$r_{DS(on)} = 0.075 \Omega$

Features:

- SOA is power-dissipation limited
- Nanosecond switching speeds
- Linear transfer characteristics
- High input impedance
- Majorly carrier device
- High-current, low-inductance package

TERMINAL DIAGRAM



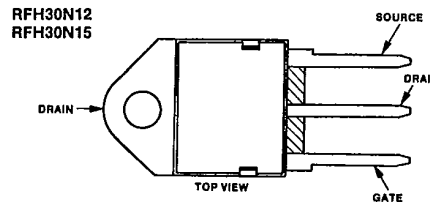
N-CHANNEL ENHANCEMENT MODE

The RFH30N12 and RFH30N15* are n-channel enhancement-mode silicon-gate power field-effect transistors designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high-power bipolar switching transistors requiring high speed and low gate-drive power. These types can be operated directly from integrated circuits.

The RFH-types are supplied in the JEDEC TO-218AC plastic package.

*The RFH30N12 and RFH30N15 types were formerly RCA developmental numbers TA9578A and TA9578B respectively.

TERMINAL DESIGNATIONS



JEDEC TO-218AC

MAXIMUM RATINGS, Absolute-Maximum Values ($T_c = 25^\circ C$):

| | RFH30N12 | RFH30N15 | |
|--|-------------|----------|---------------|
| DRAIN-SOURCE VOLTAGE | 120 | 150 | V |
| DRAIN-GATE VOLTAGE, $R_{gs} = 1 M\Omega$ | 120 | 150 | V |
| GATE-SOURCE VOLTAGE | ± 20 | | V |
| DRAIN CURRENT, RMS Continuous | 30 | | A |
| Pulsed | 100 | | A |
| POWER DISSIPATION @ $T_c = 25^\circ C$ | 150 | | W |
| Derate above $T_c = 25^\circ C$ | 1.2 | | W/ $^\circ C$ |
| OPERATING AND STORAGE TEMPERATURE | -55 to +150 | | $^\circ C$ |

RFH30N12, RFH30N15

ELECTRICAL CHARACTERISTICS, at Case Temperature (T_c) = 25° C unless otherwise specified.

| CHARACTERISTIC | SYMBOL | TEST CONDITIONS | LIMITS | | | | UNITS |
|-------------------------------------|----------------------------------|---|----------|-------|----------|-------|-------|
| | | | RFH30N12 | | RFH30N15 | | |
| | | | Min. | Max. | Min. | Max. | |
| Drain-Source Breakdown Voltage | BV _{DSS} | I _o = 1 mA V _{GS} = 0 | 120 | — | 150 | — | V |
| Gate Threshold Voltage | V _{GS(th)} | V _{GS} = V _{DS} I _D = 1 mA | 2 | 4 | 2 | 4 | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 100 V V _{DS} = 120 V | — | 1 | — | — | μA |
| | | T _c = 125° C V _{DS} = 100 V V _{DS} = 120 V | — | 50 | — | — | |
| | | | — | — | — | 50 | |
| Gate-Source Leakage Current | I _{GSS} | V _{GS} = ± 20 V V _{DS} = 0 | — | 100 | — | 100 | nA |
| On-State Gate Voltage | V _{GS(on)} ^a | V _{DS} = 5 V I _D = 15 A | — | 8 | — | 8 | V |
| | | V _{DS} = 10 V I _D = 30 A | — | 10 | — | 10 | |
| Drain-Source On Voltage | V _{DS(on)} ^a | I _D = 15 A V _{GS} = 10 V | — | 1.125 | — | 1.125 | V |
| | | I _D = 30 A V _{GS} = 10 V | — | 2.65 | — | 2.65 | |
| | | | | | | | |
| Static Drain-Source On Resistance | r _{DS(on)} ^a | I _D = 15 A V _{GS} = 10 V | — | 0.075 | — | 0.075 | Ω |
| Forward Transconductance | g _f ^a | V _{DS} = 10 V I _D = 15 A | 10 | — | 10 | — | mho |
| Input Capacitance | C _{iss} | V _{DS} = 25 V | — | 3000 | — | 3000 | pF |
| Output Capacitance | C _{oss} | V _{GS} = 0 V | — | 1200 | — | 1200 | |
| Reverse Transfer Capacitance | C _{res} | f = 1 MHz | — | 500 | — | 500 | |
| Turn-On Delay Time | t _{d(on)} | V _{DS} = 75 V | 75(typ) | 115 | 75(typ) | 115 | ns |
| Rise Time | t _r | I _D = 15 A | 420(typ) | 630 | 420(typ) | 630 | |
| Turn-Off Delay Time | t _{d(off)} | R _{gen} = R _{gs} = 50 Ω | 300(typ) | 450 | 300(typ) | 450 | |
| Fall Time | t _f | V _{GS} = 10 V | 250(typ) | 375 | 250(typ) | 375 | |
| Thermal Resistance Junction-to-Case | R _{θJC} | RFH30N12, RFH30N15 Series | — | 0.83 | — | 0.83 | °C/W |

^aPulsed: Pulse duration = 300 μs max., duty cycle = 2%.

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| CHARACTERISTIC | SYMBOL | TEST CONDITIONS | LIMITS | | | | UNITS |
|-----------------------|------------------------------|--|------------|------|------------|------|-------|
| | | | RFH30N12 | | RFH30N15 | | |
| | | | Min. | Max. | Min. | Max. | |
| Diode Forward Voltage | V _{SD} [*] | I _{SD} = 15A | — | 1.4 | — | 1.4 | V |
| Reverse Recovery Time | t _{rr} | I _F = 4A, d _I /d _i = 100 A/μs | 200 (typ.) | | 200 (typ.) | | ns |

^{*} Pulse Test: Width ≤ 300 μs, Duty cycle ≤ 2%.

RFH30N12, RFH30N15

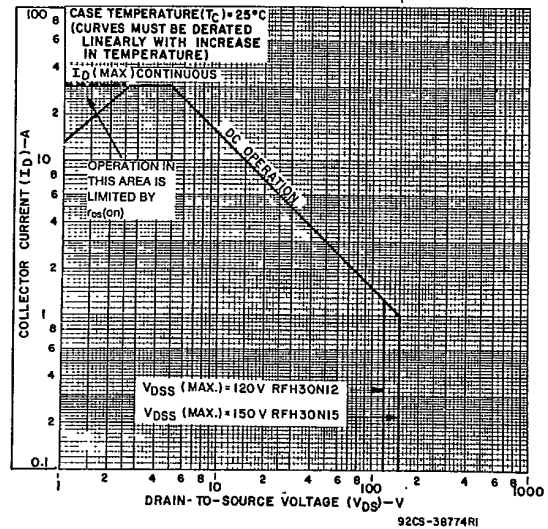


Fig. 1 - Maximum safe operating areas for all types.

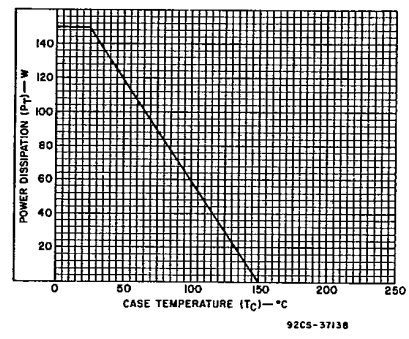


Fig. 2 - Power vs. temperature derating curve for all types.

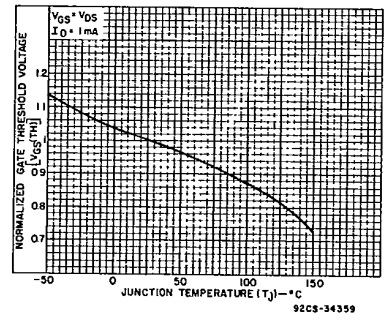


Fig. 3 - Typical normalized gate threshold voltage as a function of junction temperature for all types.

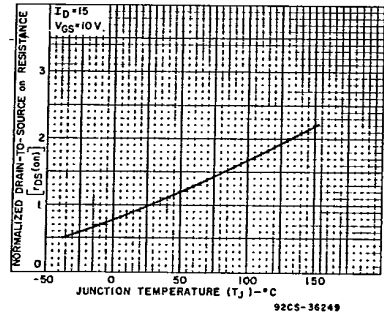


Fig. 4 - Normalized drain-to-source on resistance to junction temperature for all types.

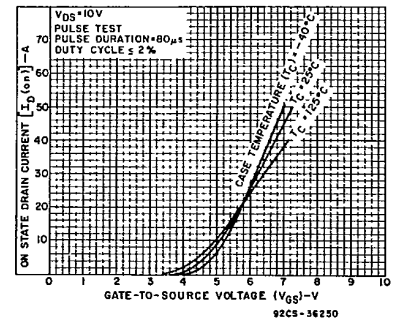


Fig. 5 - Typical transfer characteristics for all types.

RFH30N12, RFH30N15

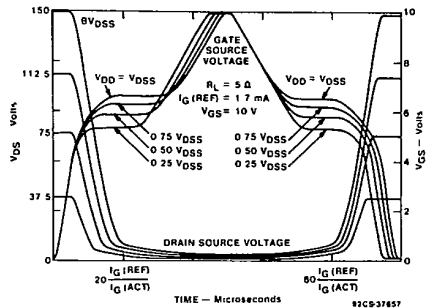


Fig. 6 - Normalized switching waveforms for constant gate-current drive.

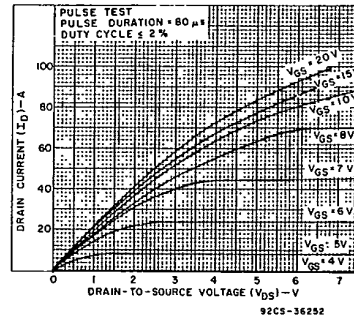


Fig. 7 - Typical saturation characteristics for all types.

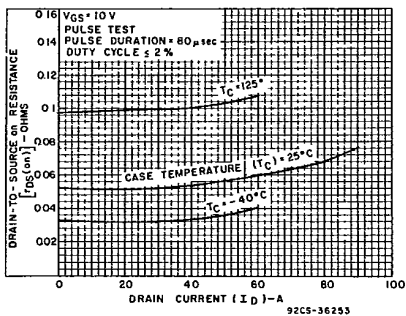


Fig. 8 - Typical drain-to-source on resistance as a function of drain current for all types.

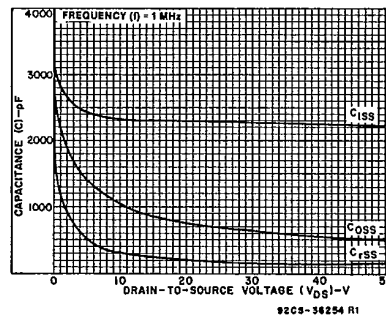


Fig. 9 - Capacitance as a function of drain-to-source voltage for all types.

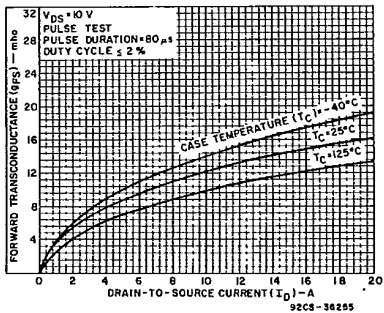


Fig. 10 - Typical forward transconductance as a function of drain current for all types.

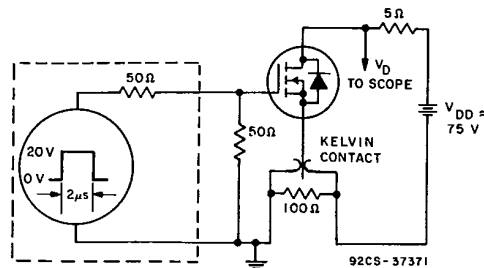


Fig. 11 - Switching Time Test Circuit.

RFK30N12, RFK30N15

File Number 1455

Power MOS Field-Effect Transistors

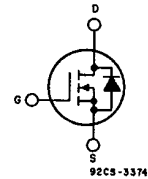
**N-Channel Enhancement-Mode
Power Field-Effect Transistors**

30 A, 120 V - 150 V
 $r_{DS(on)} = 0.075 \Omega$

Features:

- SOA is power-dissipation limited
- Nanosecond switching speeds
- Linear transfer characteristics
- High input impedance
- Majority carrier device

TERMINAL DIAGRAM



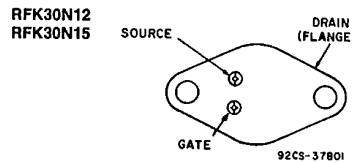
N-CHANNEL ENHANCEMENT MODE

The RFK30N12 and RFK30N15* are n-channel enhancement-mode silicon-gate power field-effect transistors designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high-power bipolar switching transistors requiring high speed and low gate-drive power. These types can be operated directly from integrated circuits.

The RFK-types are supplied in the JEDEC TO-204AE steel package.

*The RFK30N12 and RFK30N15 types were formerly RCA developmental numbers TA9188A and TA9188B, respectively.

TERMINAL DESIGNATIONS



JEDEC TO-204AE

MAXIMUM RATINGS, Absolute-Maximum Values ($T_c = 25^\circ\text{C}$):

| | RFK30N12 | RFK30N15 | |
|--|-----------------|-----------------|---------------------|
| DRAIN-SOURCE VOLTAGE | 120 | 150 | V |
| DRAIN-GATE VOLTAGE, $R_{GS} = 1 \text{ M}\Omega$ | 120 | 150 | V |
| GATE-SOURCE VOLTAGE | ± 20 | | V |
| DRAIN CURRENT, RMS Continuous | 30 | | A |
| Pulsed | 100 | | A |
| POWER DISSIPATION @ $T_c = 25^\circ\text{C}$ | 120 | | W |
| Derate above $T_c = 25^\circ\text{C}$ | 1.2 | | W/ $^\circ\text{C}$ |
| OPERATING AND STORAGE TEMPERATURE | -55 to +125 | | $^\circ\text{C}$ |

RFK30N12, RFK30N15

ELECTRICAL CHARACTERISTICS, At Case Temperature (T_c)=25°C unless otherwise specified.

| CHARACTERISTIC | SYMBOL | TEST CONDITIONS | LIMITS | | | | UNITS |
|-------------------------------------|-----------------------|---|----------|-------|----------|-------|-------|
| | | | RFK30N12 | | RFK30N15 | | |
| | | | MIN. | MAX. | MIN. | MAX. | |
| Drain-Source Breakdown Voltage | BV _{DSS} | I _D =1 mA V _{GS} =0 | 120 | — | 150 | — | V |
| Gate Threshold Voltage | V _{GS(th)} | V _{GS} =V _{DS} I _D =1 mA | 2 | 4 | 2 | 4 | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =100 V | — | 1 | — | — | μA |
| | | V _{DS} =120 V | — | — | — | 1 | |
| | | T _c =125°C V _{DS} =100 V V _{DS} =120 V | — | 50 | — | — | |
| Gate-Source Leakage Current | I _{DSS} | V _{GS} = ± 20 V, V _{DS} =0 | — | 100 | — | 100 | nA |
| Drain-Source On Voltage | V _{DS(on)} * | I _D =15 A V _{GS} =10 V | — | 1.125 | — | 1.125 | V |
| | | I _D =30 A V _{GS} =10 V | — | 3 | — | 3 | |
| | | I _D =15 A V _{GS} =10 V | — | 0.075 | — | 0.075 | |
| Static Drain-Source On Resistance | r _{DS(on)} * | I _D =15 A V _{GS} =10 V | — | 0.075 | — | 0.075 | Ω |
| Forward Transconductance | g _{fs} * | V _{DS} =10 V I _D =15 A | 10 | — | 10 | — | mho |
| Input Capacitance | C _{iss} | V _{DS} =25 V | — | 3000 | — | 3000 | pF |
| Output Capacitance | C _{oss} | V _{GS} =0 V | — | 1200 | — | 1200 | |
| Reverse Transfer Capacitance | C _{rss} | f = 1MHz | — | 500 | — | 500 | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} =75V | 75(typ) | 115 | 75(typ) | 115 | ns |
| Rise Time | t _r | I _D =15 A | 420(typ) | 630 | 420(typ) | 630 | |
| Turn-Off Delay Time | t _{d(off)} | R _{gen} =R _{gs} =50 Ω | 300(typ) | 450 | 300(typ) | 450 | |
| Fall Time | t _f | V _{GS} =10 V | 250(typ) | 375 | 250(typ) | 375 | |
| Thermal Resistance Junction-to-Case | R _{θJC} | RFK30N12, RFK30N15 Series | — | 0.83 | — | 0.83 | |

*Pulsed: Pulse duration = 300 μs max., duty cycle = 2%.

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| CHARACTERISTIC | SYMBOL | TEST CONDITIONS | LIMITS | | | | UNITS |
|-----------------------|-----------------|---|----------|------|----------|------|-------|
| | | | RFK30N12 | | RFK30N15 | | |
| | | | MIN. | MAX. | MIN. | MAX. | |
| Diode Forward Voltage | V _{SD} | I _{SD} =15 A | — | 1.4 | — | 1.4 | V |
| Reverse Recovery Time | t _r | I _F =4 A dI _F /dt=100 A/μs | 200(typ) | | 200(typ) | | ns |

*Pulse Test: Width ≤ 300 μs, duty cycle ≤ 2%.

RFK30N12, RFK30N15

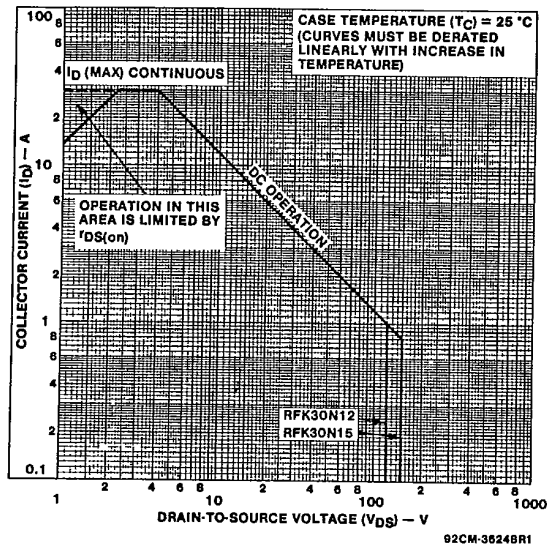


Fig. 1 - Maximum safe operating areas for all types.

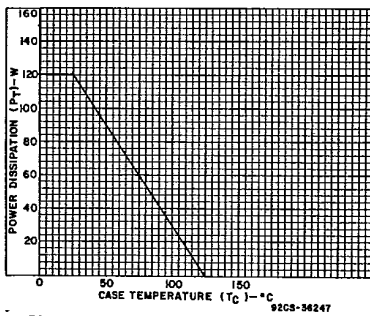


Fig. 2 - Power vs. temperature derating curve for all types.

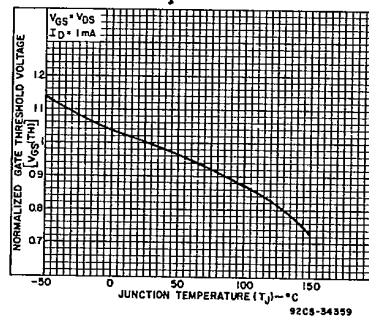


Fig. 3 - Typical normalized gate threshold voltage as a function of junction temperature for all types.

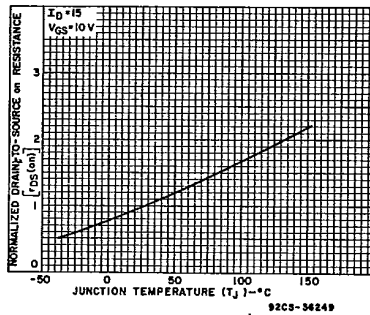


Fig. 4 - Normalized drain-to-source on resistance to junction temperature for all types.

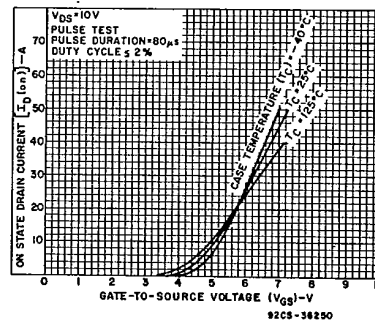


Fig. 5 - Typical transfer characteristics for all types.

RFK30N12, RFK30N15

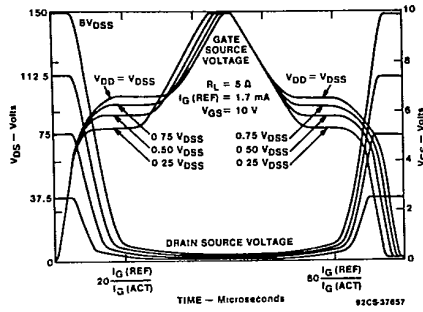


Fig. 6 - Normalized switching waveforms for constant gate-current drive.

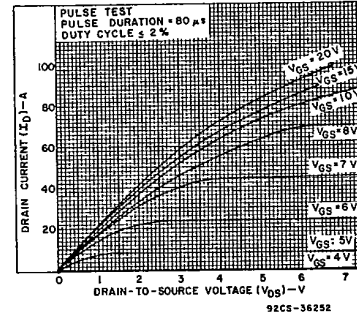


Fig. 7 - Typical saturation characteristics for all types.

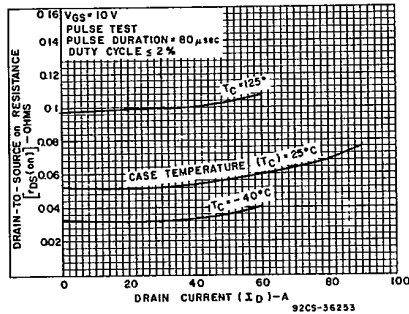


Fig. 8 - Typical drain-to-source on resistance as a function of drain current for all types.

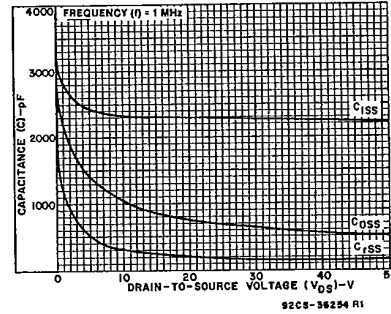


Fig. 9 - Capacitance as a function of drain-to-source voltage for all types.

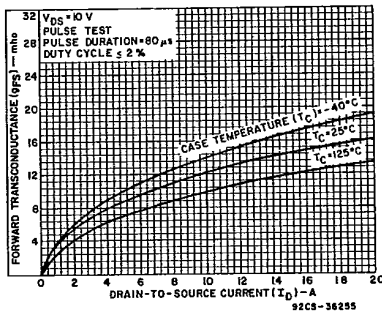


Fig. 10 - Typical forward transconductance as a function of drain current for all types.

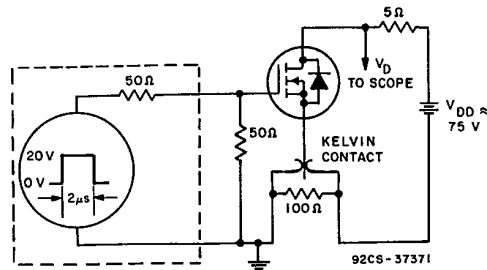


Fig. 11 - Switching Time Test Circuit